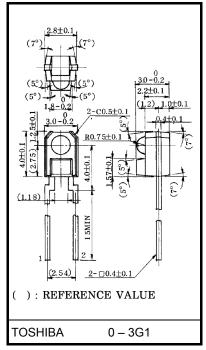
TOSHIBA Phototransistor Silicon NPN Epitaxial Planar

TPS622(F)

Lead(Pb)-Free Opto-electronic Switch Optical Mouse Optical Touch Switch

- Compact side view epoxy resin package
- High response speed: t_r, t_f = 6µs (typ.)
- Half value angle: $\theta 1/2 = \pm 15^{\circ}$ (typ.)
- Visible light cut type (black package)
- Optimum in combination with infrared LED TLN117(F) with identical external dimensions.

Characteristic	Symbol	Rating	Unit	
Collector-emitter voltage	V _{CEO}	30	V	
Emitter-collector voltage	V _{ECO}	5	V	
Collector current	Ι _C	50	mA	
Collector power dissipation	P _C	75	mW	
Collector power dissipation derating (Ta > 25°C)	ΔP _C / °C	-1	mW / °C	
Operating temperature range	T _{opr}	-25~85	°C	
Storage temperature range	T _{stg}	-40~100	°C	
Soldering temperature (5s)	T _{sol}	260 (Note 1)	°C	



Weight: 0.1 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Soldering portion of lead: At least 2mm from the body of the device.

Opto-electrical Characteristics (Ta = 25°C)

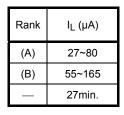
Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
Dark current		I _D (I _{CEO})	V _{CE} = 24V, E = 0		0.005	0.1	μA
Light current		۱L	E = 0.1 mW / cm ² , V _{CE} = 3 V (Note 2,3)	27	70		μA
Collector–emitter saturation voltage		V _{CE(sat)}	E = 0.1mW / cm², I _L = 15µA	_	0.15	0.4	V
Peak sensitivity wavelength		λP	—		870	_	nm
Half value angle		$\theta \frac{1}{2}$	—	_	±15		o
Switching time	Rise time	tr	$V_{CC} = 5V, I_C = 2mA$ $R_L = 100\Omega$		6	_	μs
	Fall time	t _f			6	_	

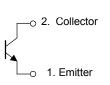
Unit in : mm



Note 2: Color temperature = 2870K standard tungsten lamp Note 3: I_L classification

Pin Connection





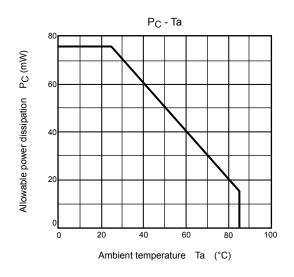
Precaution

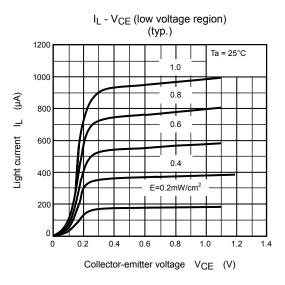
Take particular care with the following:

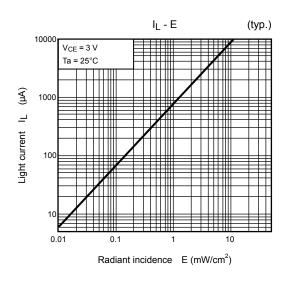
1. Lead forming should be carried out at least 2 mm from the body of the device without applying forming stress to the plastic.

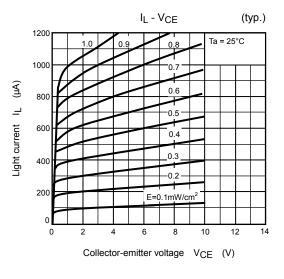
Soldering should be performed after lead forming.

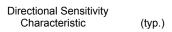
TOSHIBA



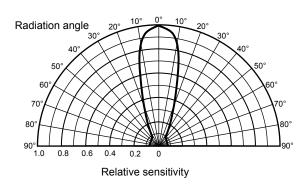


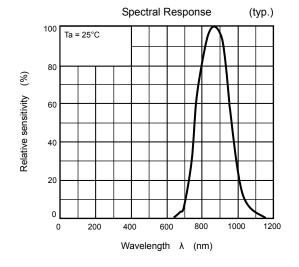






Ta = 25°C





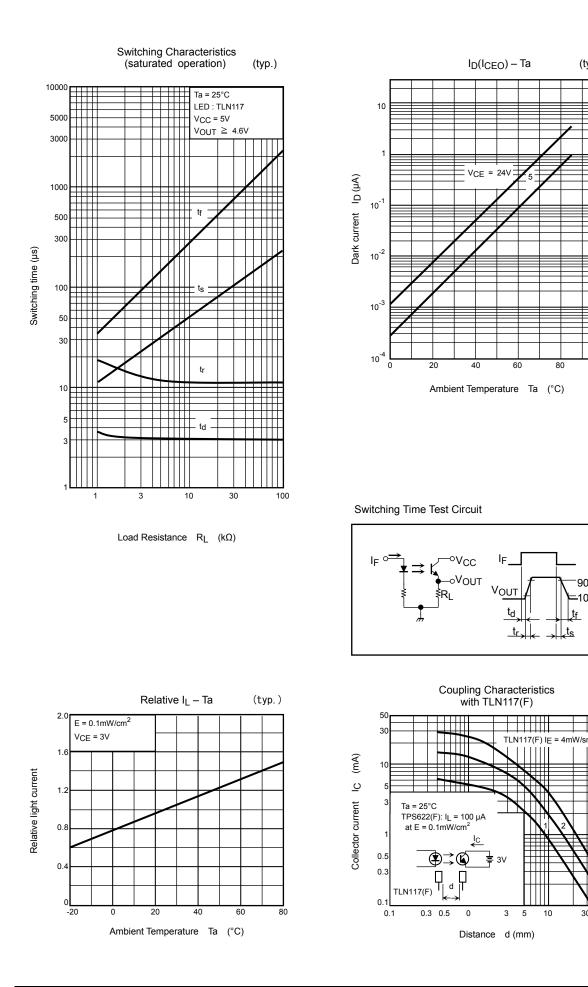
(typ.)

100

90%

-10%

tf



30 50

RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

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- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
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